



Power MOSFETS

DATASHEET

LM24500PGI3A

P-Channel
Enhancement Mode MOSFET

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Quality Management Systems

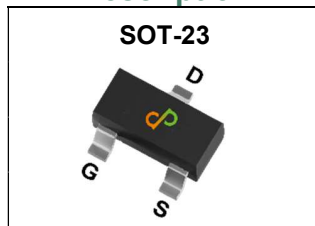
ISO 9001:2015 Certificate

LM24500PGI3A

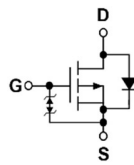


P-Channel Enhancement Mode MOSFET

Pin Description



Symbol



Product Summary

Symbol	P-Channel	Unit
V_{DS}	-24	V
$R_{DS(ON)-Max}$	50	mΩ
ID	-4.8	A

Feature

- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- ESD protection

Applications

- Portable Equipment and Battery Powered Systems.
- Load switch

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM24500PGI3A	SOT-23	Tape & Reel	3000 / Tape & Reel	25□□□

Note : □□□□□□ = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	P-Channel	Unit
V_{DS}	Drain-Source Voltage	-24	V
V_{GS}	Gate-Source Voltage	±12	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_C=25^{\circ}C$ -1	A
$I_{DM}^{①}$	Pulse Drain Current Tested	$T_C=25^{\circ}C$ -11	A
I_D	Continuous Drain Current	$T_A=25^{\circ}C$ -4.8 $T_A=70^{\circ}C$ -3.8	A
P_D	Maximum Power Dissipation	$T_A=25^{\circ}C$ 1.1 $T_A=70^{\circ}C$ 0.7	W
$I_{AS}^{②}$	Avalanche Current, Single pulse	L=0.1mH -11 L=0.5mH -6	A
$E_{AS}^{②}$	Avalanche Energy, Single pulse	L=0.1mH 6 L=0.5mH 1.8	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	Steady State 110	°C/W

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

P-Channel Electrical Characteristics ($T_J=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =-250uA	-24	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-19V, V _{GS} =0V	-	-	-1	uA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =-250uA	-0.4	-0.65	-0.9	V
I _{GSS}	Gate Leakage Current	V _{GS} =±12V, V _{DS} =0V	-	-	±10	uA
R _{DS(ON)} ④	Drain-Source On-state Resistance	V _{GS} =-4.5V, I _{DS} =-4A	-	44	50	mΩ
		V _{GS} =-2.5V, I _{DS} =-4A		55	72	
		V _{GS} =-1.8V, I _{DS} =-2A		77	115	
gfs	Forward Transconductance	V _{DS} =-5V, I _{DS} =-2A	-	5	-	S
Dynamic Characteristics ⑥						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	23	-	Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, Freq.=1MHz	-	793	-	pF
C _{oss}	Output Capacitance		-	67	-	
C _{rss}	Reverse Transfer Capacitance		-	44	-	
td(ON)	Turn-on Delay Time	V _{GS} =-4.5V, V _{DS} =-15V, I _D =-1A, R _{GEN} =6Ω	-	5	-	nS
t _r	Turn-on Rise Time		-	3	-	
t _{d(OFF)}	Turn-off Delay Time		-	94.6	-	
t _f	Turn-off Fall Time		-	56.5	-	
Q _g	Total Gate Charge	V _{GS} =-2.5V, V _{DS} =-15V I _D =-4A	-	4.5	-	nC
Q _g	Total Gate Charge	V _{GS} =-4.5V, V _{DS} =-15V, I _D =-4A	-	7.7	-	
Q _{gs}	Gate-Source Charge		-	1.8	-	
Q _{gd}	Gate-Drain Charge		-	1.6	-	
Source-Drain Characteristics						
V _{SD} ④	Diode Forward Voltage	I _{SD} =-2A, V _{GS} =0V	-	-0.8	-1.1	V
t _{rr}	Reverse Recovery Time	I _F =-2A, V _R =-15V	-	10.8	-	nS
Q _{rr}	Reverse Recovery Charge	dI _F /dt=100A/μs	-	3.5	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

P-Channel Typical Characteristics

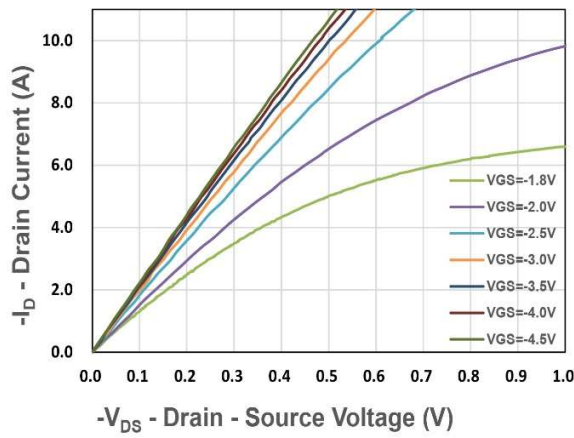


Figure 1. Output Characteristics

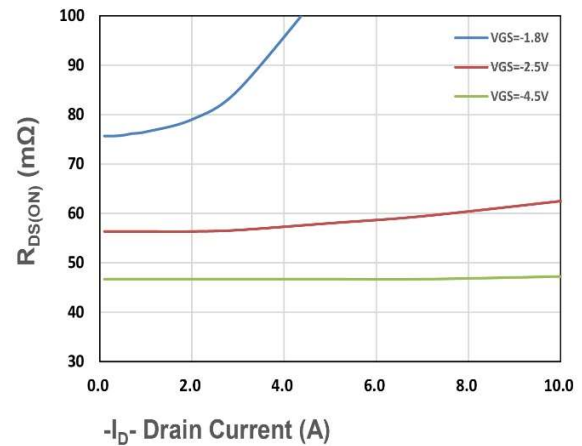


Figure 2. On-Resistance vs. ID

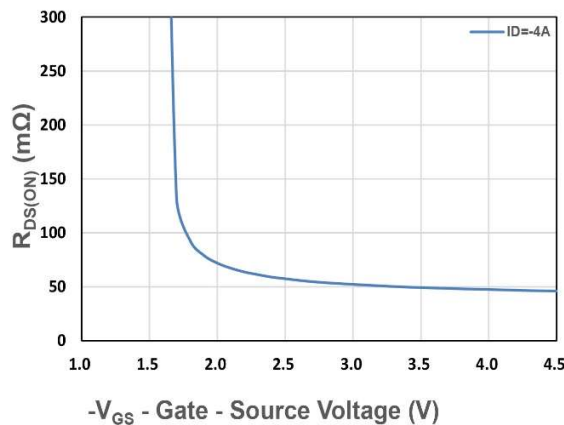


Figure 3. On-Resistance vs. VGS

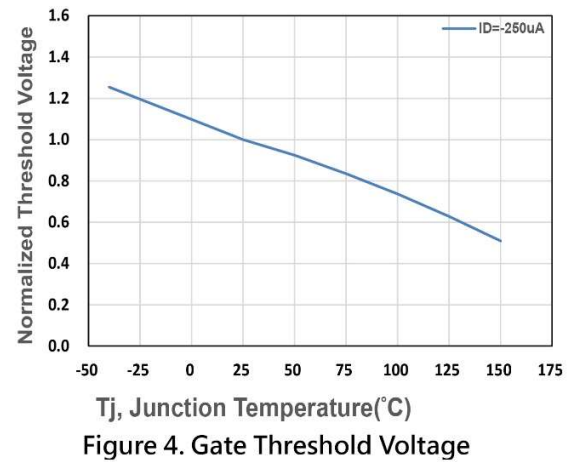


Figure 4. Gate Threshold Voltage

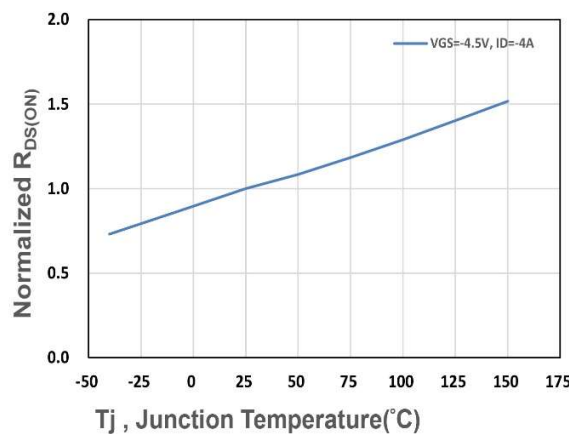


Figure 5. Drain-Source On Resistance

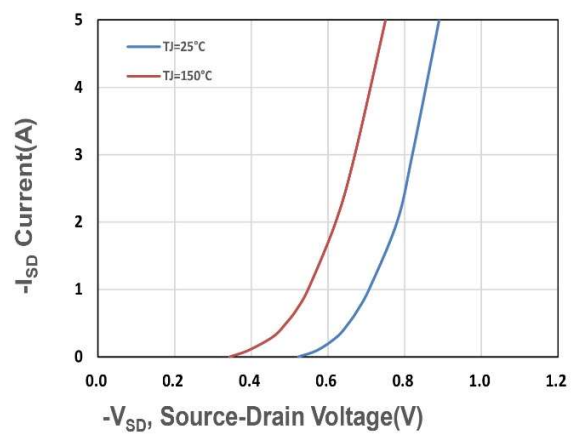
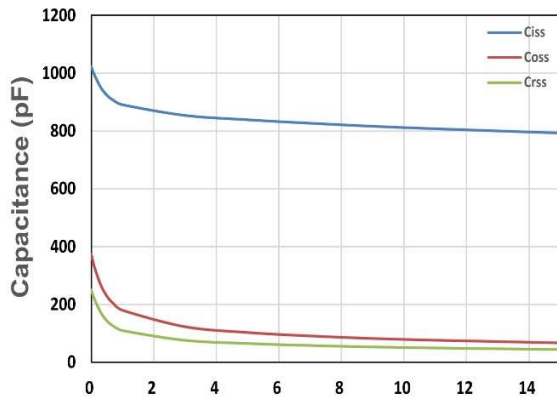
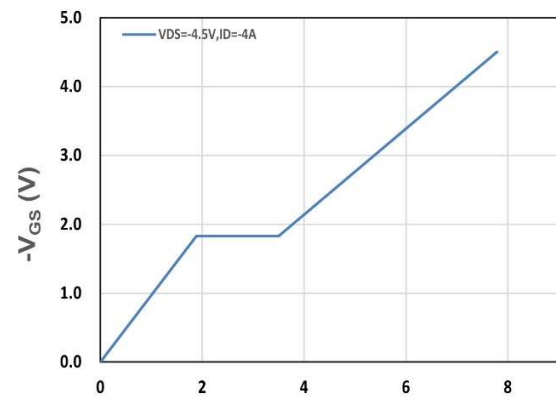


Figure 6. Source-Drain Diode Forward



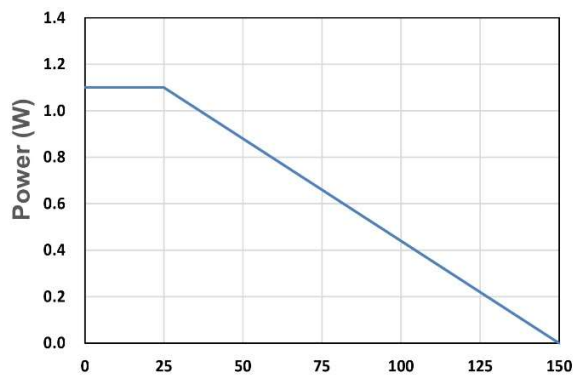
$-V_{DS}$ - Drain - Source Voltage (V)

Figure 7. Capacitance



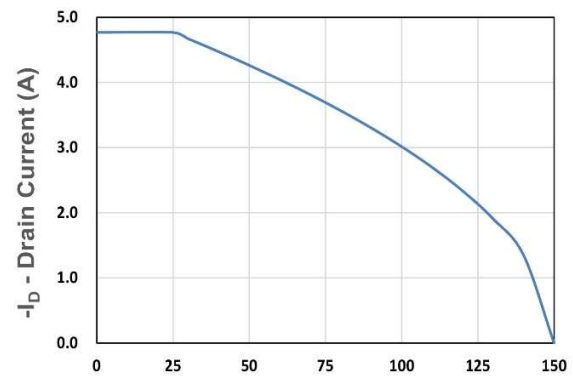
Q_g , Total Gate Charge (nC)

Figure 8. Gate Charge Characteristics



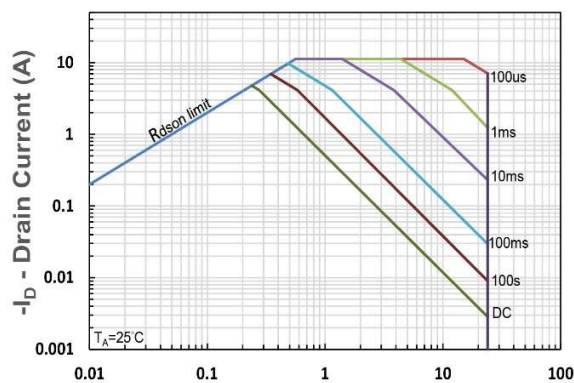
T_A - Ambient Temperature (°C)

Figure 9. Power Dissipation



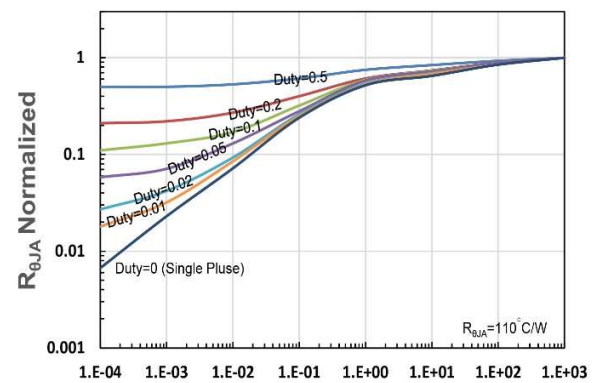
T_A - Ambient Temperature (°C)

Figure 10. Drain Current



$-V_{DS}$ - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration(s)

Figure 12. $R_{\theta JA}$ Transient Thermal Impedance